

CD54AC193/3A CD54ACT193/3A

**COMPLETE DATA SHEET
COMING SOON!**

**Pre-settable Synchronous
4-Bit Binary Up/Down Counter with Reset**

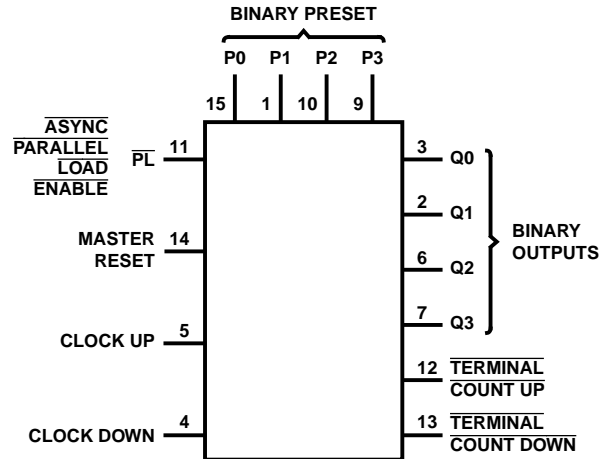
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Description

The CD54AC193/3A and CD54ACT193/3A are up/down binary counters with separate up/down clocks. These devices utilize the Harris Advanced CMOS Logic technology. Presetting the counter to the number on preset data inputs (P0-P3) is accomplished by a LOW asynchronous parallel load input (PL). The counter is incremented on the LOW-to-HIGH transition of the Clock-Up input (and a HIGH level on the Clock-Down input) and decremented on the LOW-to-HIGH transition of the Clock-Down input (and a HIGH level on the Clock-Up input). A HIGH level on the Reset input overrides any other input to clear the counter to its zero state. The TCU (carry) output goes LOW half a clock period before the zero count is reached and returns to a HIGH level at the zero count. The TCD (borrow) output in the count down mode likewise goes LOW half a clock period before the maximum count (15 counts) and returns to HIGH at the maximum count. Cascading is effected by connecting the TCU and TCD outputs of a less significant counter to the Clock-Up and Clock-Down inputs, respectively, of the next most significant counter.

The CD54AC193/3A and CD54ACT193/3A are supplied in 16-lead dual-in-line ceramic packages (F suffix).s

Functional Diagram



ACT INPUT LOAD TABLE

INPUT	UNIT LOAD (NOTE 1)
P0 - P3, \overline{PL}	0.75
MR, CPU, CPD	0.85

NOTE:

- Unit load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g., 2.4mA Max at +25°C.

Absolute Maximum Ratings

DC Supply Voltage, V_{CC} -0.5V to +6V
 DC Input Diode Current, I_{IK}
 For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$ $\pm 20mA$
 DC Output Diode Current, I_{OK}
 For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ $\pm 50mA$
 DC Output Source or Sink Current, Per Output Pin, I_O
 For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$ $\pm 50mA$
 DC V_{CC} or GND Current, I_{CC} or I_{GND}
 For Up to 4 Outputs Per Device, Add $\pm 25mA$ For Each
 Additional Output $\pm 100mA$

Power Dissipation Per Package, P_D
 $T_A = -55^\circ C$ to $+100^\circ C$ (Package F) 500mW
 $T_A = +100^\circ C$ to $+125^\circ C$ (Package F) Derate Linearly at
 8mW/ $^\circ C$ to 300mW
 Operating Temperature Range, T_A
 Package Type F $-55^\circ C$ to $+125^\circ C$
 Storage Temperature, T_{STG} $-65^\circ C$ to $+150^\circ C$
 Lead Temperature (During Soldering)
 At Distance 1/16in. \pm 1/32in. (1.59mm \pm 0.79mm)
 From Case For 10s Max $+265^\circ C$
 Unit Inserted Into a PC Board (Min Thickness 1/16in., 1.59mm)
 With Solder Contacting Lead Tips Only $+300^\circ C$

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Recommended Operating Conditions

Supply Voltage Range, V_{CC}
 Unless Otherwise Specified, All Voltages Referenced to GND
 T_A = Full Package Temperature Range
 CD54AC Types 1.5V to 5.5V
 CD54ACT Types 4.5V to 5.5V
 DC Input or Output Voltage, V_I , V_O 0V to V_{CC}

Operating Temperature, T_A $-55^\circ C$ to $+125^\circ C$
 Input Rise and Fall Slew Rate, dt/dv
 at 1.5V to 3V (AC Types) 0ns/V to 50ns/V
 at 3.6V to 5.5V (AC Types) 0ns/V to 20ns/V
 at 4.5V to 5.5V (AC Types) 0ns/V to 10ns/V